NFC Forum Type 2 Tag compliant IC with 48/128 bytes user memory

Rev. 3.0 — 14 March 2013 242330 Product data sheet COMPANY PUBLIC

## 1. General description

NTAG210 and NTAG212 have been developed by NXP Semiconductors as standard NFC tag ICs to be used in mass market applications such as retail, gaming and publishing, in combination with NFC devices or NFC compliant Proximity Coupling Devices. NTAG210 and NTAG212 (from now on, generally called NTAG21x) are designed to fully comply to NFC Forum Type 2 Tag (<u>Ref. 2</u>) and ISO/IEC14443 Type A (<u>Ref. 1</u>) specifications.

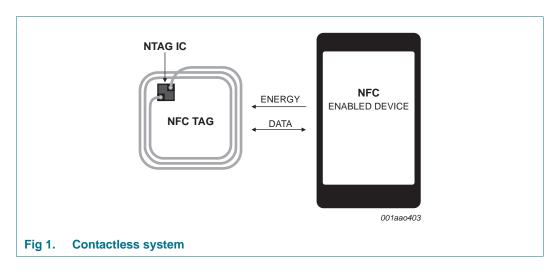
Target applications include Out-of-Home and print media smart advertisement, SoLoMo applications, product authentication, NFC shelf labels, mobile companion tags.

The mechanical and electrical specifications of NTAG21x are tailored to meet the requirements of inlay and tag manufacturers.

## 1.1 Contactless energy and data transfer

Communication to NTAG21x can be established only when the IC is connected to an antenna. Form and specification of the coil is out of scope of this document.

When NTAG21x is positioned in the RF field, the high speed RF communication interface allows the transmission of the data with a baud rate of 106 kbit/s.





## **1.2 Simple deployment and user convenience**

NTAG21x offers specific features designed to improve integration and user convenience:

- The fast read capability allows to scan the complete NDEF message with only one FAST\_READ command, thus reducing the overhead in high throughput production environments
- The improved RF performance allows for more flexibility in the choice of shape, dimension and materials
- The option for 75 μm IC thickness enables the manufacturing of ultrathin tags, for a more convenient integration in e.g. magazines or gaming cards.

## 1.3 Security

- Manufacturer programmed 7-byte UID for each device
- · Capability container with one time programmable bits
- Field programmable read-only locking function per page (per 2 pages for the extended memory section)
- ECC based originality signature
- 32-bit password protection to prevent unauthorized memory operations

## 1.4 NFC Forum Tag 2 Type compliance

NTAG21x IC provides full compliance to the NFC Forum Tag 2 Type technical specification (see <u>Ref. 2</u>) and enables NDEF data structure configurations (see <u>Ref. 3</u>).

## 1.5 Anticollision

An intelligent anticollision function allows to operate more than one tag in the field simultaneously. The anticollision algorithm selects each tag individually and ensures that the execution of a transaction with a selected tag is performed correctly without interference from another tag in the field.

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## 2. Features and benefits

- Contactless transmission of data and supply energy
- Operating frequency of 13.56 MHz
- Data transfer of 106 kbit/s
- Data integrity of 16-bit CRC, parity, bit coding, bit counting
- Operating distance up to 100 mm (depending on various parameters as e.g. field strength and antenna geometry)
- 7 byte serial number (cascade level 2 according to ISO/IEC 14443-3)
- UID ASCII mirror for automatic serialization NDEF messages
- ECC based originality signature
- Fast read command
- True anticollision

## 2.1 EEPROM

- 80 or 164 bytes organized in 20 or 41 pages with 4 bytes per page
- 48 or 128 bytes freely available user Read/Write area (12 or 32 pages)
- 4 bytes initialized capability container with one time programmable access bits
- Field programmable read-only locking function per page for the first 16 pages
- Field programmable read-only locking function per double page above the first 16 pages
- Configurable password protection with optional limit of unsuccessful attempts
- Anti-tearing support for capability container (CC) and lock bits
- ECC supported originality check
- Data retention time of 10 years
- Write endurance 100.000 cycles

## 3. Applications

- Smart advertisement
- Goods and device authentication
- Call request
- SMS
- Call to action
- Voucher and coupons
- Bluetooth simple pairing
- Connection handover

## 4. Quick reference data

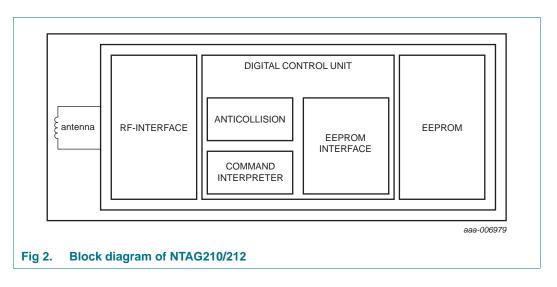
| Table 1.             | Quick reference data |                          |            |        |       |     |        |
|----------------------|----------------------|--------------------------|------------|--------|-------|-----|--------|
| Symbol               | Parameter            | Conditions               |            | Min    | Тур   | Max | Unit   |
| Ci                   | input capacitance    |                          | <u>[1]</u> | -      | 17.0  | -   | pF     |
| f <sub>i</sub>       | input frequency      |                          |            | -      | 13.56 | -   | MHz    |
| EEPROM               | characteristics      |                          |            |        |       |     |        |
| t <sub>ret</sub>     | retention time       | T <sub>amb</sub> = 22 °C |            | 10     | -     | -   | years  |
| N <sub>endu(W)</sub> | write endurance      | T <sub>amb</sub> = 22 °C |            | 100000 | -     | -   | cycles |
|                      |                      |                          |            |        |       |     |        |

[1] LCR meter,  $T_{amb} = 22 \ ^{\circ}C$ ,  $f_i = 13.56 \ \text{MHz}$ , 2 V RMS.

## 5. Ordering information

| Table 2.         Ordering information |          |   |         |  |  |  |  |
|---------------------------------------|----------|---|---------|--|--|--|--|
| Type number                           | Package  |   |         |  |  |  |  |
|                                       | Name     | Description   | Version |  |  |  |  |
| NT2L1011G0DUF                         | FFC Bump | <ul> <li>8 inch wafer, 75 μm thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps,</li> <li>48 bytes user memory, 17 pF input capacitance</li> </ul>  | -       |  |  |  |  |
| NT2L1011G0DUD                         | FFC Bump | <ul> <li>8 inch wafer, 120 μm thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps,</li> <li>48 bytes user memory, 17 pF input capacitance</li> </ul> | -       |  |  |  |  |
| NT2L1211G0DUF                         | FFC Bump | 8 inch wafer, 75 $\mu$ m thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 128 bytes user memory, 17 pF input capacitance                         | -       |  |  |  |  |
| NT2L1211G0DUD                         | FFC Bump | 8 inch wafer, 120 $\mu$ m thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 128 bytes user memory, 17 pF input capacitance                        | -       |  |  |  |  |

## 6. Block diagram



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## 7. Pinning information

## 7.1 Pinning

The pinning of the NTAG210/212 wafer delivery is shown in section "Bare die outline" (see <u>Section 13.2</u>).

| Table 3. | Pin allocation table |                       |
|----------|----------------------|-----------------------|
| Pin      | Symbol               |                       |
| LA       | LA                   | Antenna connection LA |
| LB       | LB                   | Antenna connection LB |

## 8. Functional description

## 8.1 Block description

NTAG21x ICs consist of a 80 (NTAG210) or 164 bytes (NTAG212) EEPROM, RF interface and Digital Control Unit (DCU). Energy and data are transferred via an antenna consisting of a coil with a few turns which is directly connected to NTAG21x. No further external components are necessary. Refer to <u>Ref. 4</u> for details on antenna design.

- RF interface:
  - modulator/demodulator
  - rectifier
  - clock regenerator
  - Power-On Reset (POR)
  - voltage regulator
- · Anticollision: multiple cards may be selected and managed in sequence
- Command interpreter: processes memory access commands supported by the NTAG21x
- EEPROM interface
- NTAG210 EEPROM: 80 bytes, organized in 20 pages of 4 byte per page.
  - 26 bytes reserved for manufacturer and configuration data
  - 16 bits used for the read-only locking mechanism
  - 4 bytes available as capability container
  - 48 bytes user programmable read/write memory
- NTAG212 EEPROM: 164 bytes, organized in 41 pages of 4 byte per page.
  - 26 bytes reserved for manufacturer and configuration data
  - 31 bits used for the read-only locking mechanism
  - 4 bytes available as capability container
  - 128 bytes user programmable read/write memory

## 8.2 RF interface

The RF-interface is based on the ISO/IEC 14443 Type A standard.

During operation, the NFC device generates an RF field. The RF field must always be present (with short pauses for dat communication) as it is used for both communication and as power supply for the tag.

For both directions of data communication, there is one start bit at the beginning of each frame. Each byte is transmitted with an odd parity bit at the end. The LSB of the byte with the lowest address of the selected block is transmitted first. The maximum length of a NFC device to tag frame is 163 bits (16 data bytes + 2 CRC bytes =  $16 \times 9 + 2 \times 9 + 1$  start bit). The maximum length of a fixed size tag to NFC device frame is 307 bits (32 data bytes + 2 CRC bytes =  $32 \times 9 + 2 \times 9 + 1$  start bit). The FAST\_READ command has a variable frame length depending on the start and end address parameters. The maximum frame length supported by the NFC device needs to be taken into account when issuing this command.

For a multi-byte parameter, the least significant byte is always transmitted first. As an example, when reading from the memory using the READ command, byte 0 from the addressed block is transmitted first, followed by bytes 1 to byte 3 out of this block. The same sequence continues for the next block and all subsequent blocks.

## 8.3 Data integrity

Following mechanisms are implemented in the contactless communication link between NFC device and NTAG to ensure very reliable data transmission:

- 16 bits CRC per block
- parity bits for each byte
- bit count checking
- bit coding to distinguish between "1", "0" and "no information"
- channel monitoring (protocol sequence and bit stream analysis)

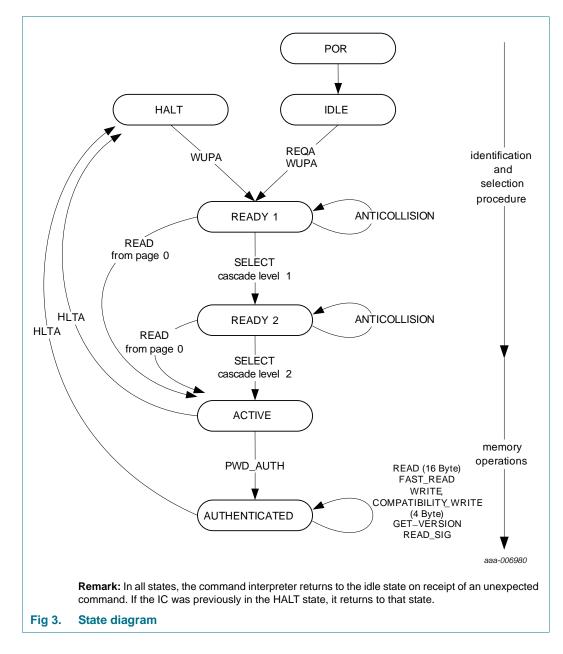
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## 8.4 Communication principle

The commands are initiated by the NFC device and controlled by the Digital Control Unit of the NTAG21x. The command response is depending on the state of the IC and for memory operations also on the access conditions valid for the corresponding page.



#### 8.4.1 IDLE state

After a power-on reset (POR), NTAG21x switches to the IDLE state. It only exits this state when a REQA or a WUPA command is received from the NFC device. Any other data received while in this state is interpreted as an error and NTAG21x remains in the IDLE state.

After a correctly executed HLTA command i.e. out of the ACTIVE or AUTHENTICATED state, the default waiting state changes from the IDLE state to the HALT state. This state can then be exited with a WUPA command only.

#### 8.4.2 READY1 state

In this state, the NFC device resolves the first part of the UID (3 bytes) using the ANTICOLLISION or SELECT commands in cascade level 1. This state is correctly exited after execution of either of the following commands:

- SELECT command from cascade level 1: the NFC device switches NTAG21x into READY2 state where the second part of the UID is resolved.
- READ command (from address 0): all anticollision mechanisms are bypassed and the NTAG21x switches directly to the ACTIVE state.

Remark: If more than one NTAG is in the NFC device field, a READ command from address 0 selects all NTAG21x devices. In this case, a collision occurs due to different serial numbers. Any other data received in the READY1 state is interpreted as an error and depending on its previous state NTAG21x returns to the IDLE or HALT state.

## 8.4.3 READY2 state

In this state, NTAG21x supports the NFC device in resolving the second part of its UID (4 bytes) with the cascade level 2 ANTICOLLISION command. This state is usually exited using the cascade level 2 SELECT command.

Alternatively, READY2 state can be skipped using a READ command (from address 0) as described for the READY1 state.

Remark: The response of NTAG21x to the cascade level 2 SELECT command is the Select AcKnowledge (SAK) byte. In accordance with ISO/IEC 14443, this byte indicates if the anticollision cascade procedure has finished. NTAG21x is now uniquely selected and only this device will communicate with the NFC device even when other contactless devices are present in the NFC device field. If more than one NTAG21x is in the NFC device field, a READ command from address 0 selects all NTAG21x devices. In this case, a collision occurs due to the different serial numbers. Any other data received when the device is in this state is interpreted as an error. Depending on its previous state the NTAG21x returns to either the IDLE state or HALT state.

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## 8.4.4 ACTIVE state

All memory operations and other functions like the originality check are operated in the ACTIVE state.

The ACTIVE state is exited with the HLTA command and upon reception NTAG21x transits to the HALT state. Any other data received when the device is in this state is interpreted as an error. Depending on its previous state NTAG21x returns to either the IDLE state or HALT state.

NTAG21x transits to the AUTHENTICATED state after successful password verification using the PWD\_AUTH command.

#### 8.4.5 AUTHENTICATED state

In this state, all operations on memory pages, which are configured as password verification protected, can be accessed.

The AUTHENTICATED state is exited with the HLTA command and upon reception NTAG21x transits to the HALT state. Any other data received when the device is in this state is interpreted as an error. Depending on its previous state NTAG21x returns to either the IDLE state or HALT state.

#### 8.4.6 HALT state

HALT and IDLE states constitute the two wait states implemented in NTAG21x. An already processed NTAG21x can be set into the HALT state using the HLTA command. In the anticollision phase, this state helps the NFC device to distinguish between processed tags and tags yet to be selected. NTAG21x can only exit this state on execution of the WUPA command. Any other data received when the device is in this state is interpreted as an error and NTAG21x state remains unchanged.

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## 8.5 Memory organization

The EEPROM memory is organized in pages with 4 bytes per page. NTAG210 variant has 20 pages and NTAG212 variant has 41 pages in total. The memory organization can be seen in <u>Figure 4</u> and <u>Figure 5</u>, the functionality of the different memory sections is described in the following sections.

|  |            | Byte number within a page |                 |               |      |     |  |  |
|--|------------|---------------------------|-----------------|---------------|------|-----|--|--|
| Description                                | 3          | 2                         | 1               | 0             | Hex  | Dec |  |  |
|  |            | umber                     | serial nu       |               | 0h   | 0   |  |  |
| Manufacturer data and<br>static lock bytes |            | umber                     | serial nu       |               | 1h   | 1   |  |  |
| Static lock bytes                          | lock bytes | lock bytes                | internal        | serial number | 2h   | 2   |  |  |
| Capability Container                       |            | ainer (CC)                | Capability Cont |               | 3h   | 3   |  |  |
|  |            |                           |                 |               | 4h   | 4   |  |  |
|  |            |                           |                 |               | 5h   | 5   |  |  |
| User memory pages                          |            | emory                     | user me         |               |      |     |  |  |
|  |            |                           |                 |               | Eh   | 14  |  |  |
|  |            |                           |                 |               | Fh   | 15  |  |  |
|  |            | G 0                       | CF              |               | 10 h | 16  |  |  |
| Configuration name                         |            | CFG 1                     |                 |               |      |     |  |  |
| Configuration pages                        |            | PWD                       |                 |               |      |     |  |  |
|  | UI         | RF                        | СК              | PAC           | 13 h | 19  |  |  |

#### Fig 4. Memory organization NTAG210

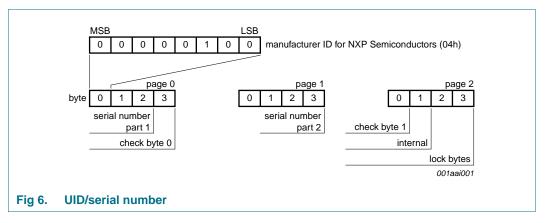
|  |            | Byte number within a page |                   |               |      |    |  |  |
|--|------------|---------------------------|-------------------|---------------|------|----|--|--|
| Description                              | 3          | 0 1 2 3                   |                   |               |      |    |  |  |
|  |            | umber                     | serial n          |               | 0h   | 0  |  |  |
| Manufacturer data a<br>static lock bytes |            | umber                     | serial n          |               | 1h   | 1  |  |  |
| Static lock bytes                        | lock bytes | lock bytes                | internal          | serial number | 2h   | 2  |  |  |
| Capability Containe                      |            | ntainer (CC)              | Capability Co     |               | 3h   | 3  |  |  |
|  |            |                           |                   |               | 4h   | 4  |  |  |
|  |            |                           |                   |               | 5h   | 5  |  |  |
| User memory page                         |            | emory                     | user me           |               |      |    |  |  |
|  |            |                           |                   |               | 22 h | 34 |  |  |
|  |            |                           |                   |               | 23 h | 35 |  |  |
| Dynamic lock bytes                       | RFUI       |                           | ynamic lock bytes | dy            | 24 h | 36 |  |  |
|  |            | CFG 0                     |                   |               |      |    |  |  |
| Configuration name                       |            | CFG 1                     |                   |               |      |    |  |  |
| Configuration page                       |            | PWD                       |                   |               |      |    |  |  |
|  | UI         | RF                        | СК                | PAG           | 28 h | 40 |  |  |

#### Fig 5. Memory organization NTAG212

The structure of manufacturing data, static lock bytes, capability container and user memory pages (except of the user memory length) are compatible to NTAG203.

#### 8.5.1 UID/serial number

The unique 7-byte serial number (UID) and its two check bytes are programmed into the first 9 bytes of memory covering page addresses 00h, 01h and the first byte of page 02h. The second byte of page address 02h is reserved for internal data. These bytes are programmed and write protected in the production test.



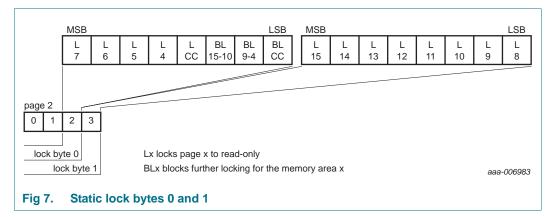
In accordance with ISO/IEC 14443-3 check byte 0 (BCC0) is defined as CT  $\oplus$  SN0  $\oplus$  SN1  $\oplus$  SN2 and check byte 1 (BCC1) is defined as SN3  $\oplus$  SN4  $\oplus$  SN5  $\oplus$  SN6.

SN0 holds the Manufacturer ID for NXP Semiconductors (04h) in accordance with ISO/IEC 14443-3.

#### 8.5.2 Static lock bytes (NTAG21x)

The bits of byte 2 and byte 3 of page 02h represent the field programmable read-only locking mechanism. Each page from 03h (CC) to 0Fh can be individually locked by setting the corresponding locking bit Lx to logic 1 to prevent further write access. After locking, the corresponding page becomes read-only memory.

The three least significant bits of lock byte 0 are the block-locking bits. Bit 2 deals with pages 0Ah to 0Fh, bit 1 deals with pages 04h to 09h and bit 0 deals with page 03h (CC). Once the block-locking bits are set, the locking configuration for the corresponding memory area is frozen.



For example if BL15-10 is set to logic 1, then bits L15 to L10 (lock byte 1, bit[7:2]) can no longer be changed. The so called static locking and block-locking bits are set by a WRITE or COMPATIBILITY\_WRITE command to page 02h. Bytes 2 and 3 of the WRITE or

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COMPATIBILITY\_WRITE command, and the contents of the lock bytes are bit-wise OR'ed and the result then becomes the new content of the lock bytes. This process is irreversible. If a bit is set to logic 1, it cannot be changed back to logic 0.

The contents of bytes 0 and 1 of page 02h are unaffected by the corresponding data bytes of the WRITE or COMPATIBILITY\_WRITE command.

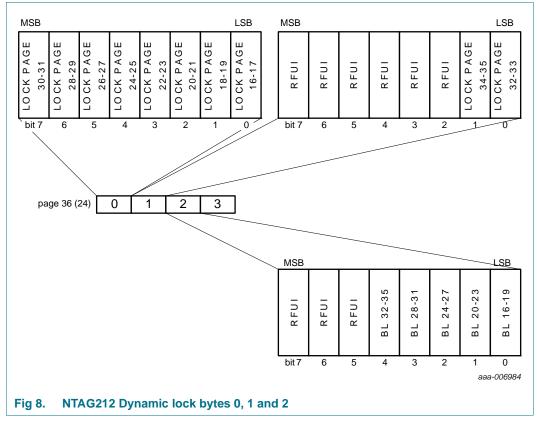
The default value of the static lock bytes is 00 00h.

Any write operation to the static lock bytes is tearing-proof.

## 8.5.3 Dynamic Lock Bytes (NTAG212 only)

To lock the pages of NTAG212 starting at page address 10h and onwards, the so called dynamic lock bytes located in page 24h are used. Those three lock bytes cover the memory area of 80 data bytes. The granularity is 2 pages, compared to a single page for the first 64 bytes as shown in Figure 8.

Remark: Set all bits marked with RFUI to 0, when writing to the dynamic lock bytes..



The default value of the dynamic lock bytes is 00 00 00h. The value of Byte 3 is always BDh when read.

Any write operation to the dynamic lock bytes is tearing-proof.

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### 8.5.4 Capability Container (CC bytes)

The Capability Container CC (page 3) is programmed during the IC production according to the NFC Forum Type 2 Tag specification (see <u>Ref. 2</u>). These bytes may be bit-wise modified by a WRITE or COMPATIBILITY\_WRITE command.

| page 3                            | Example NTAG210                            |
|-----------------------------------|--|
| byte 12 13 14 15                  | default value (initialized state) CC bytes |
|                                   | 11100001 00010000 00000110 00000000        |
| CC bytes                          | write command to page 3                    |
|                                   | 00000000 0000000 0000000 00001111          |
|                                   | result in page 3 (read-only state)         |
|                                   | 11100001 00010000 00000110 00001111        |
|                                   | aaa-006985                                 |
| This memory area can be used as a | a 32 tick one-time counter.                |
| Fig 9. CC bytes                   |  |

The parameter bytes of the WRITE command and the current contents of the CC bytes are bit-wise OR'ed. The result is the new CC byte contents. This process is irreversible and once a bit is set to logic 1, it cannot be changed back to logic 0.

Any write operation to the CC bytes is tearing-proof.

The default values of the CC bytes at delivery are defined in Section 8.5.6.

#### 8.5.5 Data pages

Pages 04h to 0Fh for NTAG210 and 04h to 23h for NTAG212 are the user memory read/write area.

The access to a part of the user memory area can be restricted using a password verification. See <u>Section 8.7</u> for further details.

The default values of the data pages at delivery are defined in <u>Section 8.5.6</u>.

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#### 8.5.6 Memory content at delivery

The capability container in page 03h and the data pages 04h and 05h of NTAG21x are pre-programmed to the initialized state according to the NFC Forum Type 2 Tag specification (see Ref. 2) as defined in Table 4 and Table 5.

#### Table 4. Memory content at delivery NTAG210

| Page Address | Byte number within page |     |     |     |  |  |
|--------------|-------------------------|-----|-----|-----|--|--|
|              | 0                       | 1   | 2   | 3   |  |  |
| 03h          | E1h                     | 10h | 06h | 00h |  |  |
| 04h          | 03h                     | 00h | FEh | 00h |  |  |
| 05h          | 00h                     | 00h | 00h | 00h |  |  |

#### Table 5. Memory content at delivery NTAG212

| Page Address | Byte number within page |     |     |     |  |  |
|--------------|-------------------------|-----|-----|-----|--|--|
|              | 0                       | 1   | 2   | 3   |  |  |
| 03h          | E1h                     | 10h | 10h | 00h |  |  |
| 04h          | 01h                     | 03h | 90h | 0Ah |  |  |
| 05h          | 34h                     | 03h | 00h | FEh |  |  |

The access to a part of the user memory area can be restricted using a password verification. Please see <u>Section 8.7</u> for further details.

**Remark:** The default content of the data pages from page 05h onwards is not defined at delivery.

## 8.5.7 Configuration pages

Pages 10h to 13h for NTAG210 and pages 25h to 28h for NTAG212 variant are used to configure the memory access restriction and to configure the UID ASCII mirror feature. The memory content of the configuration pages is detailed below.

#### Table 6. Configuration Pages

| Page Address <sup>[1]</sup> |         |             |      |             |       |  |
|-----------------------------|---------|-------------|------|-------------|-------|--|
| Dec                         | Hex     | 0           | 1    | 2           | 3     |  |
| 16/37                       | 10h/25h | MIRROR_BYTE | RFUI | MIRROR_PAGE | AUTH0 |  |
| 17/38                       | 11h/26h | ACCESS      | RFUI | RFUI        | RFUI  |  |
| 18/39                       | 12h/27h | PWD         |      |             |       |  |
| 19/40                       | 13h/28h | PAG         | СК   | RFUI        | RFUI  |  |

[1] Page address for resp. NTAG210 and NTAG212

#### Table 7. MIRROR\_BYTE configuration byte

|    |    |             | Bit nu | mber |    |    |   |
|----|----|-------------|--------|------|----|----|---|
| 7  | 6  | 5           | 4      | 3    | 2  | 1  | 0 |
| RF | UI | MIRROR_BYTE |        |      | RF | UI |   |

#### Table 8. ACCESS configuration byte

|      |        |   | Bit nu | mber |   |         |   |
|------|--------|---|--------|------|---|---------|---|
| 7    | 6      | 5 | 4      | 3    | 2 | 1       | 0 |
| PROT | CFGLCK |   | RFUI   |      |   | AUTHLIM |   |

### Table 9. Configuration parameter descriptions

|             | <u> </u> |                   | •  |
|-------------|----------|-------------------|--|
| Field       | Bit      | Default<br>values | Description  |
| MIRROR_BYTE | 2        | 00b               | The 2 bits define the byte position within the page defined by the MIRROR_PAGE byte (beginning of ASCII mirror)  |
| MIRROR_PAGE | 8        | 00h               | MIRROR_Page defines the page for the beginning of the ASCII mirroring  |
|             |          |                   | A value >03h enables the ASCII mirror feature  |
|             |          |                   | 04h-0Ch valid MIRROR_PAGE values for NTAG210   |
|             |          |                   | 04h-20h valid MIRROR_PAGE values for NTAG212   |
| AUTH0       | 8        | FFh               | AUTH0 defines the page address from which the password verification is required.<br>Valid address range for byte AUTH0 is from 00h to FFh.<br>If AUTH0 is set to a page address which is higher than the last page from the user |
| PROT        | 4        | Oh                | configuration, the password protection is effectively disabled.  |
| PROT        | I        | 0b                | One bit inside the ACCESS byte defining the memory protection  |
|             |          |                   | 0b write access is protected by the password verification  |
|             |          |                   | 1b read and write access is protected by the password verification   |
| CFGLCK      | 1        | 0b                | Write locking bit for the user configuration   |
|             |          |                   | 0b user configuration open to write access   |
|             |          |                   | 1b user configuration permanently locked against write access  |
| AUTHLIM     | 3        | 000b              | Limitation of negative password verification attempts  |
|             |          |                   | 000b limiting of negative password verification attempts disabled  |
|             |          |                   | 001b-111b maximum number of negative password verification attempts  |
| NTAG210_212 |          |                   | All information provided in this document is subject to legal disclaimers. © NXP B.V. 2013. All rights reserved.   |

| Table 9. | Configuratio | Configuration parameter descriptions |  |  |  |  |  |  |
|----------|--------------|--------------------------------------|--|--|--|--|--|--|
| Field    | Bit          | Default<br>values                    | Description  |  |  |  |  |  |
| PWD      | 32           | FFFFFFFh                             | 32-bit password used for memory access protection                                      |  |  |  |  |  |
| PACK     | 16           | 0000h                                | 16-bit password acknowledge used during the password verification process              |  |  |  |  |  |
| RFUI     | -            | all 0b                               | Reserved for future use - implemented. Write all bits and bytes denoted as RFUI as 0b. |  |  |  |  |  |

**Remark:** The CFGLCK bit activates the permanent write protection of the first two configuration pages. The write lock is only activated after a power cycle of NTAG21x. If write protection is enabled, each write attempt leads to a NAK response.

## 8.6 UID ASCII mirror function

NTAG21x features a UID ASCII mirror function. This function enables NTAG21x to virtually mirror the 7 byte UID in ASCII code into the physical memory of the IC. The length of the UID ASCII mirror requires 14 bytes to mirror the UID in ASCII code. On the READ or FAST READ command to the involved user memory pages, NTAG21x will respond with the virtual memory content of the UID in ASCII code.

The position within the user memory where the mirroring of the UID shall start is defined by the MIRROR\_PAGE and MIRROR\_BYTE values.

The MIRROR\_PAGE value defines the page where the UID ASCII mirror shall start and the MIRROR\_BYTE value defines the starting byte within the defined page.

The UID ASCII mirror function is enabled with a MIRROR\_PAGE value >03h.

**Remark:** Please note that the 14 bytes of the UID ASCII mirror shall not exceed the boundary of the user memory. Therefor it is required to use only valid values for MIRROR\_BYTE and MIRROR\_PAGE to ensure a proper functionality.

#### Table 10. Configuration parameter descriptions

|                | MIRROR_PAGE               | MIRROR_BYTE bits |
|----------------|---------------------------|------------------|
| Minimum values | 04h                       | 00b - 11b        |
| Maximum value  | last user memory page - 3 | 10b              |

#### 8.6.1 UID ASCII Mirror example

Table 11 show the memory content of a NTAG210 which has been written to the physical memory. Without the UID ASCII mirror feature, the content in the user memory would be a URL according to the NFC Data Exchange Format (NDEF) Ref. 3 with the content:

http://www.nxp.com/index.html?m=000000000000000

| Table 11. | Physical | memory | content |
|-----------|----------|--------|---------|
|-----------|----------|--------|---------|

| Page add | iress | Byte nu |          |     |            |       |
|----------|-------|---------|----------|-----|------------|-------|
| dec.     | hex.  | 0       | 1        | 2   | 3          | ASCII |
| 0        | 00h   | 04      | E1       | 41  | 2C         |       |
| 1        | 01h   | 12      | 4C       | 28  | 80         |       |
| 2        | 02h   | F6      | internal |     | lock bytes |       |
| 3        | 03h   | E1      | 10       | 06  | 00         |       |
| 4        | 04h   | 03      | 28       | D1  | 01         | .(    |
| 5        | 05h   | 23      | 55       | 01  | 6E         | #U.n  |
| 6        | 06h   | 78      | 70       | 2E  | 63         | xp.c  |
| 7        | 07h   | 6F      | 6D       | 2F  | 69         | om/i  |
| 8        | 08h   | 6E      | 64       | 65  | 78         | ndex  |
| 9        | 09h   | 2E      | 68       | 74  | 6D         | .htm  |
| 10       | 0Ah   | 6C      | 3F       | 6D  | 3D         | l?m=  |
| 11       | 0Bh   | 30      | 30       | 30  | 30         | 0000  |
| 12       | 0Ch   | 30      | 30       | 30  | 30         | 0000  |
| 13       | 0Dh   | 30      | 30       | 30  | 00         | 0000  |
| 14       | 0Eh   | 30      | 30       | FE  | 00         | 00    |
| 15       | 0Fh   | 00      | 00       | 00  | AUTH_D     | ATA   |
| 16       | 10h   | 00      | RFUI     | 0B  |            |       |
| 17       | 11h   | Access  |          |     |            |       |
| 18       | 12h   |         |          | PWD |            |       |
| 19       | 13h   |         | PACK     |     | RFUI       |       |

With the UID Mirror feature and the related values in the MIRROR\_PAGE and the MIRROR\_BYTE the UID 04-E1-41-12-4C-28-80h will be mirrored in ASCII code into the user memory starting in page 0Bh byte 0. The virtual memory content is shown in Table 12.

Reading the user memory, the data will be returned as an URL according to the NFC Data Exchange Format (NDEF) <u>Ref. 3</u> with the content:

http://www.nxp.com/index.html?m=04E141124C2880

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| Table 12. | Virtual men | nory content |          |     |            |           |
|-----------|-------------|--------------|----------|-----|------------|-----------|
| Page add  | ress        | Byte num     | ber      |     |            |           |
| dec.      | hex.        | 0            | 1        | 2   | 3          | ASCII     |
| 0         | 00h         | 04           | E1       | 41  | 2C         |           |
| 1         | 01h         | 12           | 4C       | 28  | 80         |           |
| 2         | 02h         | F6           | internal |     | lock bytes |           |
| 3         | 03h         | E1           | 10       | 06  | 00         |           |
| 4         | 04h         | 03           | 28       | D1  | 01         | .(        |
| 5         | 05h         | 23           | 55       | 01  | 6E         | #U.n      |
| 6         | 06h         | 78           | 70       | 2E  | 63         | xp.c      |
| 7         | 07h         | 6F           | 6D       | 2F  | 69         | om/i      |
| 8         | 08h         | 6E           | 64       | 65  | 78         | ndex      |
| 9         | 09h         | 2E           | 68       | 74  | 6D         | .htm      |
| 10        | 0Ah         | 6C           | 3F       | 6D  | 3D         | l?m=      |
| 11        | 0Bh         | 30           | 34       | 45  | 31         | 04E1      |
| 12        | 0Ch         | 34           | 31       | 31  | 32         | 4112      |
| 13        | 0Dh         | 34           | 43       | 32  | 38         | 4C28      |
| 14        | 0Eh         | 38           | 30       | FE  | 00         | <b>80</b> |
| 15        | 0Fh         | 00           | 00       | 00  | AUTH_D/    | ATA       |
| 16        | 10h         | 00           | RFUI     | 0B  |            |           |
| 17        | 11h         | Access       |          |     |            |           |
| 18        | 12h         |              |          | PWD |            |           |
| 19        | 13h         |              | PACK     |     | RFUI       |           |

#### Table 12. Virtual memory content

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## 8.7 Password verification protection

The memory write or read/write access to a configurable part of the memory can be constrained to a positive password verification. The 32-bit secret password (PWD) and the 16-bit password acknowledge (PACK) response are typically programmed into the configuration pages at the tag personalization stage.

The AUTHLIM parameter specified in <u>Section 8.5.7</u> can be used to limit the negative verification attempts.

In the initial state of NTAG21x, password protection is disabled by a AUTH0 value of FFh. PWD and PACK are freely writable in this state. Access to the configuration pages and any part of the user memory can be restricted by setting AUTH0 to a page address within the available memory space. This page address is the first one protected.

**Remark:** The password protection method provided in NTAG21x has to be intended as an easy and convenient way to prevent unauthorized memory accesses. If a higher level of protection is required, cryptographic methods can be implemented at application layer to increase overall system security.

## 8.7.1 Programming of PWD and PACK

The 32-bit PWD and the 16-bit PACK need to be programmed into the configuration pages, see <u>Section 8.5.7</u>. The password as well as the password acknowledge are written LSByte first. This byte order is the same as the byte order used during the PWD\_AUTH command and its response.

The PWD and PACK bytes can never be read out of the memory. Instead of transmitting the real value on any valid READ or FAST\_READ command, only 00h bytes are replied.

If the password verification does not protect the configuration pages, PWD and PACK can be written with normal WRITE and COMPATIBILITY\_WRITE commands.

If the configuration pages are protected by the password configuration, PWD and PACK can be written after a successful PWD\_AUTH command.

The PWD and PACK are writable even if the CFGLCK bit is set to 1b. Therefore it is strongly recommended to set AUTH0 to the page where the PWD is located after the password has been written. This page is 12h for NTAG210 and 27h for NTAG212.

**Remark:** To improve the overall system security, it is advisable to diversify the password and the password acknowledge using a die individual parameter of the iC, that is the 7-byte UID available on NTAG21x.

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**COMPANY PUBLIC** 

#### 8.7.2 Limiting negative verification attempts

To prevent brute-force attacks on the password, the maximum allowed number of negative password verification attempts can be set using AUTHLIM. This mechanism is disabled by setting AUTHLIM to a value of 000b, which is also the initial state of NTAG21x.

If AUTHLIM is not equal to 000b, each negative authentication verification is internally counted. As soon as this internal counter reaches the number specified in AUTHLIM, any further negative password verification leads to a permanent locking of the protected part of the memory for the specified access modes. Specifically, whether the provided password is correct or not, each subsequent PWD\_AUTH fails.

Any successful password verification, before reaching the limit of negative password verification attempts, resets the internal counter to zero.

#### 8.7.3 Protection of special memory segments

The configuration pages can be protected by the password authentication as well. The protection level is defined with the PROT bit.

The protection is enabled by setting the AUTH0 byte to a value that is within the addressable memory space.

## 8.8 Originality signature

NTAG21x features a cryptographically supported originality check. With this feature, it is possible to verify with a certain confidence that the tag is using an IC manufactured by NXP Semiconductors. This check can be performed on personalized tags as well.

NTAG21x digital signature is based on standard Elliptic Curve Cryptography (curve name *secp128r1*), according to the ECDSA algorithm. The use of a standard algorithm and curve ensures easy software integration of the originality check procedure in NFC devices without specific hardware requirements.

Each NTAG21x UID is signed with a NXP private key and the resulting 32-byte signature is stored in a hidden part of the NTAG21x memory during IC production.

This signature can be retrieved using the READ\_SIG command and can be verified in the NFC device by using the corresponding ECC public key provided by NXP. In case the NXP public key is stored in the NFC device, the complete signature verification procedure can be performed offline.

To verify the signature (for example with the use of the public domain crypto library *OpenSSL*) the tool domain parameters shall be set to *secp128r1*, defined within the standards for elliptic curve cryptography SEC (Ref. 7).

Details on how to check the signature value are provided in following application note (Ref. 5). It is foreseen to offer an online and offline way to verify originality of NTAG21x.

## 9. Command overview

NTAG activation follows the ISO/IEC 14443 Type A. After NTAG21x has been selected, it can either be deactivated using the ISO/IEC 14443 HLTA command, or the NTAG commands (e.g. READ or WRITE) can be performed. For more details about the card activation refer to <u>Ref. 1</u>.

## 9.1 NTAG21x command overview

All available commands for NTAG21x are shown in Table 13.

| Command <sup>[1]</sup>     | ISO/IEC 14443     | NFC FORUM   | Command code<br>(hexadecimal) |
|----------------------------|-------------------|-------------|-------------------------------|
| Request                    | REQA              | SENS_REQ    | 26h (7 bit)                   |
| Wake-up                    | WUPA              | ALL_REQ     | 52h (7 bit)                   |
| Anticollision CL1          | Anticollision CL1 | SDD_REQ CL1 | 93h 20h                       |
| Select CL1                 | Select CL1        | SEL_REQ CL1 | 93h 70h                       |
| Anticollision CL2          | Anticollision CL2 | SDD_REQ CL2 | 95h 20h                       |
| Select CL2                 | Select CL2        | SEL_REQ CL2 | 95h 70h                       |
| Halt                       | HLTA              | SLP_REQ     | 50h 00h                       |
| GET_VERSION <sup>[2]</sup> | -                 | -           | 60h                           |
| READ                       | -                 | READ        | 30h                           |
| FAST_READ <sup>[2]</sup>   | -                 | -           | 3Ah                           |
| WRITE                      | -                 | WRITE       | A2h                           |
| COMP_WRITE                 | -                 | -           | A0h                           |
| PWD_AUTH <sup>[2]</sup>    | -                 | -           | 1Bh                           |
| READ_SIG <sup>[2]</sup>    | -                 | -           | 3Ch                           |

#### Table 13. Command overview

[1] Unless otherwise specified, all commands use the coding and framing as described in <u>Ref. 1</u>.

[2] This command is new in NTAG21x compared to NTAG203.

## 9.2 Timings

The command and response timings shown in this document are not to scale and values are rounded to 1  $\mu s.$ 

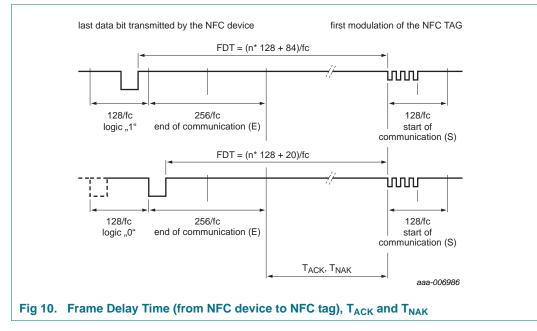
All given command and response times refer to the data frames including start of communication and end of communication. They do not include the encoding (like the Miller pulses). A NFC device data frame contains the start of communication (1 "start bit") and the end of communication (one logic 0 + 1 bit length of unmodulated carrier). A NFC tag data frame contains the start of communication (1 "start bit") and the end of communication the start of communication (1 "start bit") and the end of communication (1 bit length of no subcarrier).

The minimum command response time is specified according to <u>Ref. 1</u> as an integer n which specifies the NFC device to NFC tag frame delay time. The frame delay time from NFC tag to NFC device is at least 87  $\mu$ s. The maximum command response time is specified as a time-out value. Depending on the command, the T<sub>ACK</sub> value specified for command responses defines the NFC device to NFC tag frame delay time. It does it for either the 4-bit ACK value specified in <u>Section 9.3</u> or for a data frame.

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All timing can be measured according to ISO/IEC 14443-3 frame specification as shown for the Frame Delay Time in Figure 10. For more details refer to Ref. 1.



**Remark:** Due to the coding of commands, the measured timings usually excludes (a part of) the end of communication. Considered this factor when comparing the specified with the measured times.

## 9.3 NTAG ACK and NAK

NTAG uses a 4 bit ACK / NAK as shown in Table 14.

| Table 14. ACK | and NAK values                                       |
|---------------|--|
| Code (4-bit)  | ACK/NAK  |
| Ah            | Acknowledge (ACK)                                    |
| 0h            | NAK for invalid argument (i.e. invalid page address) |
| 1h            | NAK for parity or CRC error                          |
| 5h            | NAK for EEPROM write error                           |

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## 9.4 ATQA and SAK responses

NTAG21x replies to a REQA or WUPA command with the ATQA value shown in <u>Table 15</u>. It replies to a Select CL2 command with the SAK value shown in <u>Table 16</u>. The 2-byte ATQA value is transmitted with the least significant byte first (44h).

#### Table 15. ATQA response of the NTAG21x

|            |           | Bit number |    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |
|------------|-----------|------------|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|
| Sales type | Hex value | 16         | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| NTAG21x    | 00 44h    | 0          | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 |

#### Table 16. SAK response of the NTAG21x

|            |           |   |   |   | Bit nu | Imper | ſ |   |   |
|------------|-----------|---|---|---|--------|-------|---|---|---|
| Sales type | Hex value | 8 | 7 | 6 | 5      | 4     | 3 | 2 | 1 |
| NTAG21x    | 00h       | 0 | 0 | 0 | 0      | 0     | 0 | 0 | 0 |

**Remark:** The ATQA coding in bits 7 and 8 indicate the UID size according to ISO/IEC 14443 independent from the settings of the UID usage.

**Remark:** The bit numbering in the ISO/IEC 14443 starts with LSB = bit 1 and not with LSB = bit 0. So 1 byte counts bit 1 to bit 8 instead of bit 0 to 7.

## **10. NTAG commands**

## 10.1 GET\_VERSION

The GET\_VERSION command is used to retrieve information on the NTAG family, the product version, storage size and other product data required to identify the specific NTAG21x.

This command is also available on other NTAG products to have a common way of identifying products across platforms and evolution steps.

The GET\_VERSION command has no arguments and replies the version information for the specific NTAG21x type. The command structure is shown in <u>Figure 11</u> and <u>Table 17</u>.

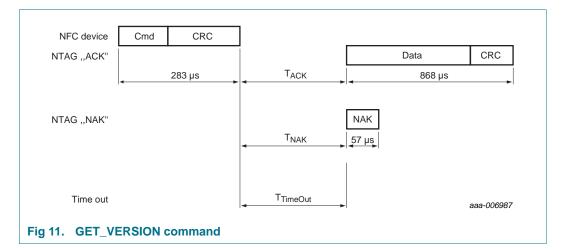


Table 18 shows the required timing.

#### Table 17. GET\_VERSION command

| Name | Code         | Description                    | Length  |
|------|--------------|--------------------------------|---------|
| Cmd  | 60h          | Get product version            | 1 byte  |
| CRC  | -            | CRC according to Ref. 1        | 2 bytes |
| Data | -            | Product version information, s | 8 bytes |
| NAK  | see Table 14 | see Section 9.3                | 4-bit   |

#### Table 18. GET\_VERSION timing

These times exclude the end of communication of the NFC device.

|             | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|-------------|---------------------------|---------------------------|----------------------|
| GET_VERSION | n=9 <mark>[1]</mark>      | T <sub>TimeOut</sub>      | 5 ms                 |

[1] Refer to <u>Section 9.2 "Timings"</u>.

| Table 19. GET_VERSION response for NTAG210 and NTAG212 |                       |         |         |                           |  |  |  |  |
|--|-----------------------|---------|---------|---------------------------|--|--|--|--|
| Byte no.   | Description           | NTAG210 | NTAG212 | Interpretation            |  |  |  |  |
| 0  | fixed Header          | 00h     | 00h     |                           |  |  |  |  |
| 1  | vendor ID             | 04h     | 04h     | NXP Semiconductors        |  |  |  |  |
| 2  | product type          | 04h     | 04h     | NTAG                      |  |  |  |  |
| 3  | product subtype       | 01h     | 01h     | 17 pF                     |  |  |  |  |
| 4  | major product version | 01h     | 01h     | 1                         |  |  |  |  |
| 5  | minor product version | 00h     | 00h     | VO                        |  |  |  |  |
| 6  | storage size          | 0Bh     | 0Eh     | see following information |  |  |  |  |
| 7  | protocol type         | 03h     | 03h     | ISO/IEC 14443-3 compliant |  |  |  |  |

 Table 19.
 GET\_VERSION response for NTAG210 and NTAG212

The most significant 7 bits of the storage size byte are interpreted as a unsigned integer value n. As a result, it codes the total available user memory size as  $2^n$ . If the least significant bit is 0b, the user memory size is exactly  $2^n$ . If the least significant bit is 1b, the user memory size is between  $2^n$  and  $2^{n+1}$ .

The user memory for NTAG210 is 48 bytes. This memory size is between 32 bytes and 64 bytes. Therefore, the most significant 7 bits of the value 0Bh, are interpreted as 5d and the least significant bit is 1b.

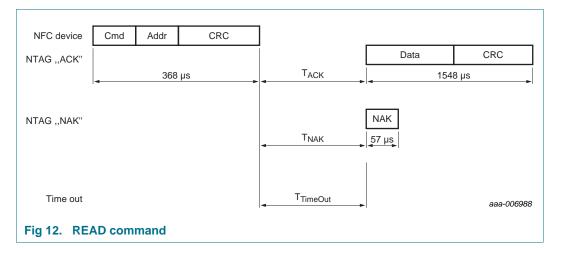
The user memory for NTAG212 is 128 bytes. This memory size is exactly 128 bytes. Therefore, the most significant 7 bits of the value 0Eh, are interpreted as 7d and the least significant bit is 0b.

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## 10.2 READ

The READ command requires a start page address, and returns the 16 bytes of four NTAG21x pages. For example, if address (Addr) is 03h then pages 03h, 04h, 05h, 06h are returned. Special conditions apply if the READ command address is near the end of the accessible memory area. The special conditions also apply if at least part of the addressed pages is within a password protected area. For details on those cases and the command structure refer to Figure 11 and Table 17.

Table 21 shows the required timing.



#### Table 20.READ command

| Name | Code         | Description                         | Length   |
|------|--------------|-------------------------------------|----------|
| Cmd  | 30h          | read four pages                     | 1 byte   |
| Addr | -            | start page address                  | 1 byte   |
| CRC  | -            | CRC according to Ref. 1             | 2 bytes  |
| Data | -            | Data content of the addressed pages | 16 bytes |
| NAK  | see Table 14 | see Section 9.3                     | 4-bit    |

#### Table 21. READ timing

These times exclude the end of communication of the NFC device.

|      | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|------|---------------------------|---------------------------|----------------------|
| READ | n=9 <mark>[1]</mark>      | T <sub>TimeOut</sub>      | 5 ms                 |

[1] Refer to Section 9.2 "Timings".

In the initial state of NTAG21x, all memory pages are allowed as Addr parameter to the READ command.

- page address 00h to 13h for NTAG210
- page address 00h to 28h for NTAG212

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

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A roll-over mechanism is implemented to continue reading from page 00h once the end of the accessible memory is reached. Reading from address 11h on a NTAG210 results in pages 11h, 12h, 13h and 00h being returned.

The following conditions apply if part of the memory is password protected for read access:

- if NTAG21x is in the ACTIVE state
  - addressing a page which is equal or higher than AUTH0 results in a NAK response
  - addressing a page lower than AUTH0 results in data being returned with the roll-over mechanism occurring just before the AUTH0 defined page
- if NTAG21x is in the AUTHENTICATED state
  - the READ command behaves like on a NTAG21x without access protection

**Remark:** PWD and PACK values can never be read out of the memory. When reading from the pages holding those two values, all 00h bytes are replied to the NFC device instead.

## 10.3 FAST\_READ

The FAST\_READ command requires a start page address and an end page address and returns the all n\*4 bytes of the addressed pages. For example if the start address is 03h and the end address is 07h then pages 03h, 04h, 05h, 06h and 07h are returned. If the addressed page is outside of accessible area, NTAG21x replies a NAK. For details on those cases and the command structure, refer to Figure 13 and Table 22.

Table 23 shows the required timing.

| NFC device  | Cmd  | StartAddr | EndAddr | CRC |                  |                |                  |
|-------------|------|-----------|---------|-----|------------------|----------------|------------------|
| NTAG "ACK"  |      | •         |         |     |                  | Data           | CRC              |
|             |      | 45        | 3 µs    |     | T <sub>ACK</sub> | depending on I | nr of read pages |
| NTAG "NAK"  |      |           |         |     | T <sub>NAK</sub> | NAK<br>57 μs   |                  |
| Time out    |      |           |         |     | TTimeOut         |                | aaa-006989       |
| Fig 13. FAS | T_RE | AD com    | mand    |     |                  |                |                  |

#### Table 22. FAST\_READ command

| Name      | Code         | Description                         | Length    |
|-----------|--------------|-------------------------------------|-----------|
| Cmd       | 3Ah          | read multiple pages                 | 1 byte    |
| StartAddr | -            | start page address                  | 1 byte    |
| EndAddr   | -            | end page address                    | 1 byte    |
| CRC       | -            | CRC according to Ref. 1             | 2 bytes   |
| Data      | -            | data content of the addressed pages | n*4 bytes |
| NAK       | see Table 14 | see Section 9.3                     | 4-bit     |

#### Table 23. FAST\_READ timing

These times exclude the end of communication of the NFC device.

|           | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|-----------|---------------------------|---------------------------|----------------------|
| FAST_READ | n=9 <mark>[1]</mark>      | T <sub>TimeOut</sub>      | 5 ms                 |

[1] Refer to Section 9.2 "Timings".

In the initial state of NTAG21x, all memory pages are allowed as StartAddr parameter to the FAST\_READ command.

- page address 00h to 13h for NTAG210
- page address 00h to 28h for NTAG212

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

The EndAddr parameter must be equal to or higher than the StartAddr.

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The following conditions apply if part of the memory is password protected for read access:

• if NTAG21x is in the ACTIVE state

- if any requested page address is equal or higher than AUTH0 a NAK is replied

- if NTAG21x is in the AUTHENTICATED state
  - the FAST\_READ command behaves like on a NTAG21x without access protection

**Remark:** PWD and PACK values can never be read out of the memory. When reading from the pages holding those two values, all 00h bytes are replied to the NFC device instead.

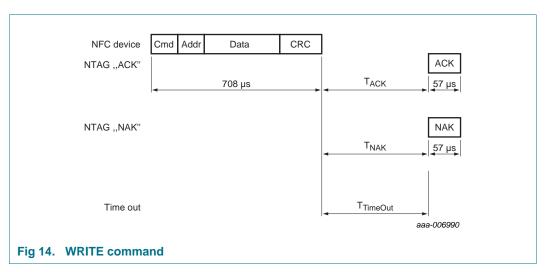
**Remark:** The FAST\_READ command is able to read out the whole memory with one command. Nevertheless, receive buffer of the NFC device must be able to handle the requested amount of data as there is no chaining possibility.

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## **10.4 WRITE**

The WRITE command requires a block address, and writes 4 bytes of data into the addressed NTAG21x page. The WRITE command is shown in Figure 14 and Table 24.

Table 25 shows the required timing.



#### Table 24.WRITE command

| Name | Code         | Description             | Length  |
|------|--------------|-------------------------|---------|
| Cmd  | A2h          | write one page          | 1 byte  |
| Addr | -            | page address            | 1 byte  |
| CRC  | -            | CRC according to Ref. 1 | 2 bytes |
| Data | -            | data                    | 4 bytes |
| NAK  | see Table 14 | see Section 9.3         | 4-bit   |

#### Table 25. WRITE timing

These times exclude the end of communication of the NFC device.

|       | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|-------|---------------------------|---------------------------|----------------------|
| WRITE | n=9[1]                    | T <sub>TimeOut</sub>      | 10 ms                |

[1] Refer to <u>Section 9.2 "Timings"</u>.

In the initial state of NTAG21x, the following memory pages are valid Addr parameters to the WRITE command.

- page address 02h to 13h for NTAG210
- page address 02h to 28h for NTAG212

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

Pages which are locked against writing cannot be reprogrammed using any write command. The locking mechanisms include static and dynamic lock bits as well as the locking of the configuration pages.

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The following conditions apply if part of the memory is password protected for write access:

- if NTAG21x is in the ACTIVE state
  - writing to a page which address is equal or higher than AUTH0 results in a NAK response
- if NTAG21x is in the AUTHENTICATED state
  - the WRITE command behaves like on a NTAG21x without access protection

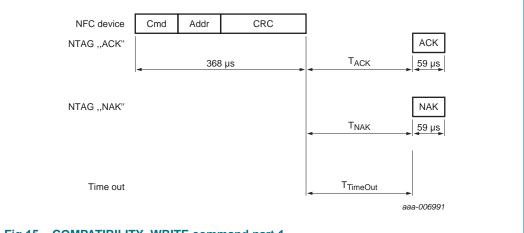
NTAG21x features tearing protected write operations to specific memory content. The following pages are protected against tearing events during a WRITE operation:

- page 2 containing static lock bits
- page 3 containing CC bits
- page 36 containing the additional dynamic lock bits for the NTAG212

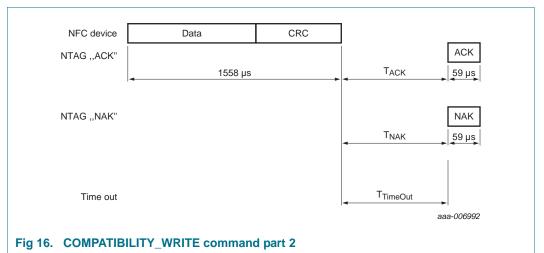
## **10.5 COMPATIBILITY WRITE**

The COMPATIBILITY\_WRITE command is implemented to guarantee interoperability with the established MIFARE Classic PCD infrastructure, in case of coexistence of ticketing and NFC applications. Even though 16 bytes are transferred to NTAG21x, only the least significant 4 bytes (bytes 0 to 3) are written to the specified address. Set all the remaining bytes, 04h to 0Fh, to logic 00h. The COMPATIBILITY\_WRITE command is shown in Figure 15, Figure 16 and Table 24.

Table 27 shows the required timing.







| Table 26. | Table 26. COMPATIBILITY_WRITE command |  |          |  |  |
|-----------|---------------------------------------|--|----------|--|--|
| Name      | Code                                  | Description  | Length   |  |  |
| Cmd       | A0h                                   | compatibility write                                      | 1 byte   |  |  |
| Addr      | -                                     | page address   | 1 byte   |  |  |
| CRC       | -                                     | CRC according to Ref. 1                                  | 2 bytes  |  |  |
| Data      | -                                     | 16-byte Data, only least significant 4 bytes are written | 16 bytes |  |  |
| NAK       | see Table 14                          | see Section 9.3  | 4-bit    |  |  |

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#### Table 27. COMPATIBILITY\_WRITE timing

These times exclude the end of communication of the NFC device.

|                            | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|----------------------------|---------------------------|---------------------------|----------------------|
| COMPATIBILITY_WRITE part 1 | n=9 <mark>[1]</mark>      | T <sub>TimeOut</sub>      | 5 ms                 |
| COMPATIBILITY_WRITE part 2 | n=9 <u>[1]</u>            | T <sub>TimeOut</sub>      | 10 ms                |

[1] Refer to Section 9.2 "Timings".

In the initial state of NTAG21x, the following memory pages are valid Addr parameters to the COMPATIBILITY\_WRITE command.

- page address 02h to 13h for NTAG210
- page address 02h to 28h for NTAG212

Addressing a memory page beyond the limits above results in a NAK response from NTAG21x.

Pages which are locked against writing cannot be reprogrammed using any write command. The locking mechanisms include static and dynamic lock bits as well as the locking of the configuration pages.

The following conditions apply if part of the memory is password protected for write access:

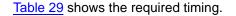
- if NTAG21x is in the ACTIVE state
  - writing to a page which address is equal or higher than AUTH0 results in a NAK response
- if NTAG21x is in the AUTHENTICATED state
  - the COMPATIBILITY\_WRITE command behaves the same as on a NTAG21x without access protection

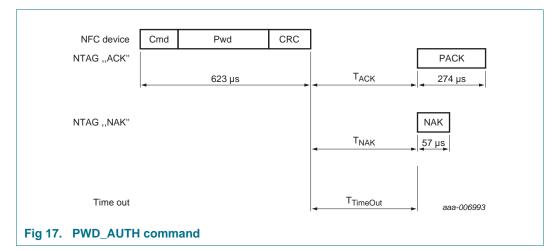
NTAG21x features tearing protected write operations to specific memory content. The following pages are protected against tearing events during a COMPATIBILITY\_WRITE operation:

- page 2 containing static lock bits
- page 3 containing CC bits
- page 36 containing the additional dynamic lock bits for the NTAG212

## 10.6 PWD\_AUTH

A protected memory area can be accessed only after a successful password verification using the PWD\_AUTH command. The AUTH0 configuration byte defines the protected area. It specifies the first page that the password mechanism protects. The level of protection can be configured using the PROT bit either for write protection or read/write protection. The PWD\_AUTH command takes the password as parameter and, if successful, returns the password authentication acknowledge, PACK. By setting the AUTHLIM configuration bits to a value larger than 000b, the number of unsuccessful password verifications can be limited. Each unsuccessful authentication is then counted in a counter featuring anti-tearing support. After reaching the limit of unsuccessful attempts, the memory access specified in PROT, is no longer possible. The PWD\_AUTH command is shown in Figure 17 and Table 28.





## Table 28. PWD\_AUTH command

| Name | Code         | Description                         | Length  |
|------|--------------|-------------------------------------|---------|
| Cmd  | 1Bh          | password authentication             | 1 byte  |
| Pwd  | -            | password                            | 4 bytes |
| CRC  | -            | CRC according to Ref. 1             | 2 bytes |
| PACK | -            | password authentication acknowledge | 2 bytes |
| NAK  | see Table 14 | see Section 9.3                     | 4-bit   |

#### Table 29. PWD\_AUTH timing

These times exclude the end of communication of the NFC device.

|          | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|----------|---------------------------|---------------------------|----------------------|
| PWD_AUTH | n=9 <u>[1]</u>            | T <sub>TimeOut</sub>      | 5 ms                 |

[1] Refer to Section 9.2 "Timings".

**Remark:** It is strongly recommended to change the password from its delivery state at tag issuing and set the AUTH0 value to the PWD page.

## 10.7 READ\_SIG

The READ\_SIG command returns an IC specific, 32-byte ECC signature, to verify NXP Semiconductors as the silicon vendor. The signature is programmed at chip production and cannot be changed afterwards. The command structure is shown in <u>Figure 18</u> and <u>Table 30</u>.

Table 31 shows the required timing.

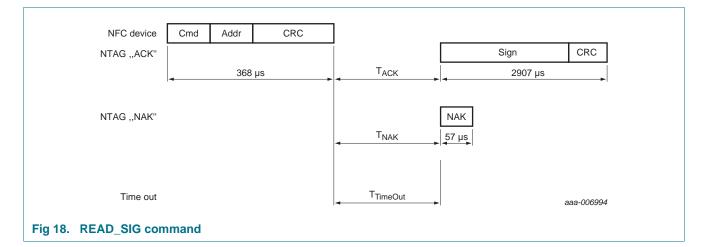


Table 30. READ\_SIG command

| Name      | Code         | Description             | Length   |
|-----------|--------------|-------------------------|----------|
| Cmd       | 3Ch          | read ECC signature      | 1 byte   |
| Addr      | 00h          | RFU, is set to 00h      | 1 byte   |
| CRC       | -            | CRC according to Ref. 1 | 2 bytes  |
| Signature | -            | ECC signature           | 32 bytes |
| NAK       | see Table 14 | see Section 9.3         | 4 bit    |

#### Table 31. READ\_SIG timing

These times exclude the end of communication of the NFC device.

|          | T <sub>ACK/NACK</sub> min | T <sub>ACK/NACK</sub> max | T <sub>TimeOut</sub> |
|----------|---------------------------|---------------------------|----------------------|
| READ_SIG | n=9[1]                    | T <sub>TimeOut</sub>      | 5 ms                 |

[1] Refer to Section 9.2 "Timings".

Details on how to check the signature value are provided in the following Application note (Ref. 5). It is foreseen to offer an online and offline way to verify originality of NTAG21x.

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#### NFC Forum Type 2 Tag compliant IC with 48/128 bytes user memory

## **11. Limiting values**

Stresses exceeding one or more of the limiting values can cause permanent damage to the device. Exposure to limiting values for extended periods can affect device reliability.

#### Table 32. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                                | Min | Max | Unit |
|------------------|--|-----|-----|------|
| l <sub>l</sub>   | input current                            | -   | 40  | mA   |
| P <sub>tot</sub> | total power dissipation                  | -   | 120 | mW   |
| T <sub>stg</sub> | storage temperature                      | -55 | 125 | °C   |
| T <sub>amb</sub> | ambient temperature                      | -25 | 70  | °C   |
| V <sub>ESD</sub> | electrostatic discharge voltage on LA/LB | l 2 | -   | kV   |

[1] ANSI/ESDA/JEDEC JS-001; Human body model: C = 100 pF, R =  $1.5 \text{ k}\Omega$ 

## **12. Characteristics**

| Table 33.              | Characteristics   |                            |            |         |       |     |       |
|------------------------|-------------------|----------------------------|------------|---------|-------|-----|-------|
| Symbol                 | Parameter         | Conditions                 |            | Min     | Тур   | Max | Unit  |
| Ci                     | input capacitance |                            | <u>[1]</u> | -       | 17.0  | -   | pF    |
| f <sub>i</sub>         | input frequency   |                            |            | -       | 13.56 | -   | MHz   |
| EEPROM characteristics |                   |                            |            |         |       |     |       |
| t <sub>ret</sub>       | retention time    | $T_{amb} = 22 \ ^{\circ}C$ |            | 10      | -     | -   | year  |
| N <sub>endu(W)</sub>   | write endurance   | T <sub>amb</sub> = 22 °C   |            | 100.000 | -     | -   | cycle |

[1] LCR meter,  $T_{amb} = 22 \ ^{\circ}C$ ,  $f_i = 13.56 \ MHz$ , 2 V RMS.

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## 13. Wafer specification

For more details on the wafer delivery forms see Ref. 5.

| Wafer                                 |                                    |
|---------------------------------------|------------------------------------|
| diameter                              | 200 mm typical (8 inches)          |
| maximum diameter after foil expansion | 210 mm                             |
| thickness                             |                                    |
| NT2L1011G0DUD and NT2L1211G0DUD       | 120 $\mu m \pm$ 15 $\mu m$         |
| NT2L1011G0DUF and NT2L1211G0DUF       | 75 $\mu$ m $\pm$ 10 $\mu$ m        |
| flatness                              | not applicable                     |
| Potential Good Dies per Wafer (PGDW)  | 103682                             |
| Wafer backside                        |                                    |
| material                              | Si                                 |
| treatment                             | ground and stress relieve          |
| roughness                             | R <sub>a</sub> max = 0.5 μm        |
|                                       | $R_t max = 5 \mu m$                |
| Chip dimensions                       |                                    |
| step size <sup>[1]</sup>              | x = 505 μm                         |
|                                       | y = 590 μm                         |
| gap between chips <sup>[1]</sup>      | typical = 20 μm                    |
|                                       | minimum = 5 μm                     |
| Passivation                           |                                    |
| type                                  | sandwich structure                 |
| material                              | PSG / nitride                      |
| thickness                             | 500 nm / 600 nm                    |
| Au bump (substrate connected to VSS)  |                                    |
| material                              | > 99.9 % pure Au                   |
| hardness                              | 35 to 80 HV 0.005                  |
| shear strength                        | > 70 MPa                           |
| height                                | 18 μm                              |
| height uniformity                     | within a die = $\pm 2 \ \mu m$     |
|                                       | within a wafer = $\pm 3 \ \mu m$   |
|                                       | wafer to wafer = $\pm 4 \ \mu m$   |
| flatness                              | minimum = $\pm 1.5 \ \mu m$        |
| size                                  | LA, LB, GND, TΡ[2] = 60 μm × 60 μm |
| size variation                        | ±5 μm                              |
| under bump metallization              | sputtered TiW                      |

[1] The step size and the gap between chips may vary due to changing foil expansion

[2] Pads GND and TP are disconnected when wafer is sawn

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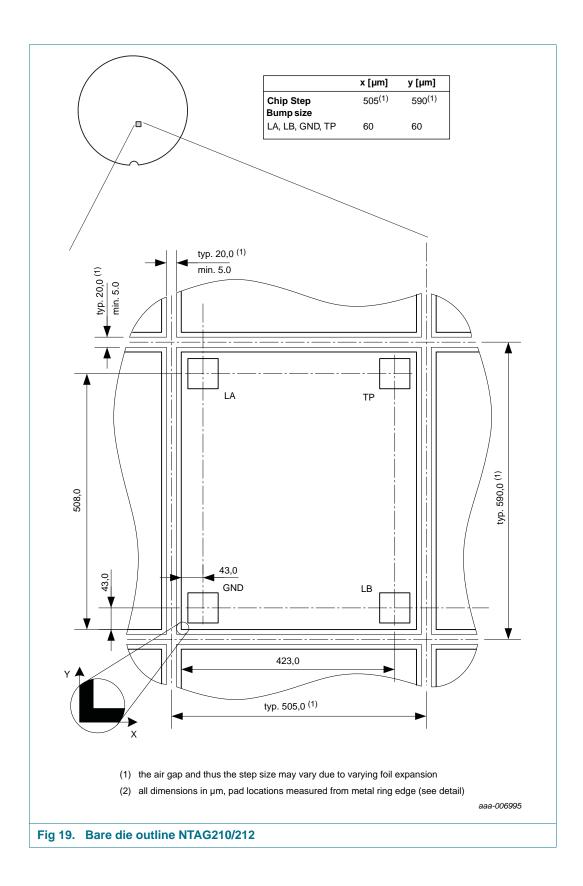
## 13.1 Fail die identification

Electronic wafer mapping covers the electrical test results and additionally the results of mechanical/visual inspection. No ink dots are applied.

## 13.2 Bare die outline

For more details on the wafer delivery forms see Ref. 5.

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# 14. Abbreviations

| Table 35. | Abbreviations and symbols                                    |
|-----------|--|
| Acronym   | Description  |
| ACK       | ACKnowledge  |
| ATQA      | Answer To reQuest, Type A                                    |
| CRC       | Cyclic Redundancy Check                                      |
| CC        | Capability container   |
| СТ        | Cascade Tag (value 88h) as defined in ISO/IEC 14443-3 Type A |
| ECC       | Elliptic Curve Cryptography                                  |
| EEPROM    | Electrically Erasable Programmable Read-Only Memory          |
| FDT       | Frame Delay Time   |
| FFC       | Film Frame Carrier   |
| IC        | Integrated Circuit   |
| LCR       | L = inductance, Capacitance, Resistance (LCR meter)          |
| LSB       | Least Significant Bit  |
| NAK       | Not AcKnowledge  |
| NFC devic | e NFC Forum device   |
| NFC tag   | NFC Forum tag  |
| NV        | Non-Volatile memory  |
| REQA      | REQuest command, Type A                                      |
| RF        | Radio Frequency  |
| RFUI      | Reserver for Future Use - Implemented                        |
| RMS       | Root Mean Square   |
| SAK       | Select AcKnowledge, type A                                   |
| SECS-II   | SEMI Equipment Communications Standard part 2                |
| TiW       | Titanium Tungsten  |
| UID       | Unique IDentifier  |
| WUPA      | Wake-Up Protocol type A                                      |
| -         |  |

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## **15. References**

- [1] ISO/IEC 14443 International Organization for Standardization
- [2] NFC Forum Tag 2 Type Operation, Technical Specification NFC Forum, 31.05.2011, Version 1.1
- [3] NFC Data Exchange Format (NDEF), Technical Specification NFC Forum, 24.07.2006, Version 1.0
- [4] AN11276 NTAG Antenna Design Guide Application note, BU-ID Document number 2421\*\*1
- [5] AN11350 NTAG21x Originality Signature Validation Application note, BU-ID Document number 2604\*\*
- [6] General specification for 8" wafer on UV-tape; delivery types Delivery Type Description, BU-ID Document number 1005\*\*
- [7] Certicom Research. SEC 2 Recommended Elliptic Curve Domain Parameters, version 2.0, January 2010

<sup>1. \*\* ...</sup> BU ID document version number

# **16. Revision history**

| story                              |   |   |  |
|------------------------------------|---|---|--|
| Release date                       | Data sheet status   | Change notice   | Supersedes   |
| 20130314                           | Product data sheet  | -   | NTAG210_242320   |
| <ul> <li>Editorial cha</li> </ul>  | anges   |   |  |
| <ul> <li>Security state</li> </ul> | tus changed into COMPANY                                  | PUBLIC  |  |
| 20121219                           | Preliminary data sheet                                    | -   | -  |
| <ul> <li>Initial versio</li> </ul> | n   |   |  |
|                                    | 20130314<br>• Editorial cha<br>• Security sta<br>20121219 | Release date       Data sheet status         20130314       Product data sheet         • Editorial changes       • Security status changed into COMPANY         20121219       Preliminary data sheet | Release date       Data sheet status       Change notice         20130314       Product data sheet       -         • Editorial changes       • Security status changed into COMPANY PUBLIC         20121219       Preliminary data sheet       - |

## 17. Legal information

## 17.1 Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
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# 19. Tables

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